

10/586275

IAP11 Rec'd PCT/PTO 18 JUL 2006

11 South Meridian Street  
Indianapolis, Indiana 46204  
(317) 236-1313  
(317) 231-7433 Fax

## IN THE UNITED STATES PATENT OFFICE

*Earliest Priority*      20 January 2004 (20.01.04)  
*Date:*

*International Serial No.:*      PCT/US2004/037345

*U.S. Serial No.:*      Unknown

*Invention:*      MATERIAL PUMP

*Applicant:*      SCHAUPP, John F.

*International Filing Date:*      08 November 2004 (08.11.04)

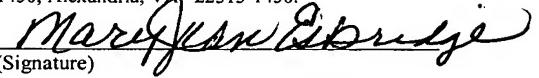
*Attorney Docket:*      3030-200329

}      Certificate Under 37 CFR 1.10

}      Express Mail No.: EV 633514092 US

}      Date of Mailing: 18 July 2006

}      I hereby certify that this correspondence is being deposited with the United States Postal Service's "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date above and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

}      

}      Mary Jean Eskridge

}      (Typed or Printed Name of Person Mailing Paper or Fee)

## FIRST PRELIMINARY AMENDMENT

Attn: DO/EO/US  
Mail Stop: PCT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Preliminary to the examination of the above-identified national patent application submitted herewith, Applicant requests entry of the following amendments.

**Amendments to the Description** begin on page 3 of this paper.

**Submission of Formal Drawings and two sheets of formal drawings are attached hereto.**

**Remarks** begin on page 4 of this paper.

**In the Description**

Please amend the description as follows:

On page 1, immediately after the first section heading, please amend the accompanying paragraph:

CROSS-REFERENCE TO RELATED APPLICATIONS

This application is a U.S. national application under 37 C.F.R. § 371(b) of International Application Serial No. PCT/US2004/037345 filed November 8, 2004, which claims the benefit, under 35 U.S.C. § 119(e), of the filing date of U. S. patent application 60/537,774 filed January 20, 2004, assigned to the same assignee as this application. The disclosure of U. S. patent application 60/537,774 is hereby incorporated herein by reference.